

# Bill of Materials

TI DESIGNS



TIDM-GMR-WATERMTR

Designator	Value	Quantity	Description	DigiKey PN
R11, R13	0Ω	2	0402 SMD Chip Resistor	311-0.0JRCT-ND
C1	10uF	1	0805 SMD Chip Capacitor	490-3886-1-ND
C11, C2	100nF	2	0402 SMD Chip Capacitor	490-3261-1-ND
U1	AA002-02	1	GMR Sensor	391-1045-5-ND
ESI	SFH11-PBPC-D08-ST-BK	1	Connector	S9196-ND
C21	DNP	0	0402 SMD Chip Capacitor	
U2	DNP	0	GMR Sensor	
R12, R14, R21, R22, R23, R24	DNP	0	0402 SMD Chip Resistor	

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